

AD 581-42
3/23/07
11/663550

11/663550

AP13 Rec'd PCT/PTO 23 MAR 2007
U.S. DEPARTMENT OF COMMERCE

Form PTO-1595 (Rev. 03-05)
OMB No. 0651-0027 (exp. 6/30/2005)

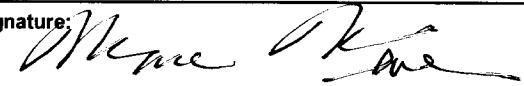
RECORDATION FORM COVER SHEET
PATENTS ONLY

03-30-2007



103389382

To the Director of the U.S. Patent and Trademark Office: Please record the attached document

<p>1. Name of conveying party(ies): Ikuo KUSHIDA (12/26/2006), Eriko DOI (12/26/2006), and Koichi ITO (12/26/2006)</p> <p>Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>	<p>2. Name and address of re 103389382</p> <p>Name: <u>Eisai R&D Management Co., Ltd.</u></p> <p>Internal Address: _____</p> <p>Street Address: _____</p> <p>6-10, Koishikawa 4-chome, Bunkyo-ku Tokyo JAPAN</p> <p>City: _____</p> <p>State: _____</p> <p>Country: _____ Zip: _____</p> <p>Additional name(s) & address(es) attached: <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>
<p>3. Nature of conveyance/Execution Date(s):</p> <p>Execution Date(s): <u>in parentheses after inventor name</u></p> <p><input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Change of Name</p> <p><input type="checkbox"/> Security Agreement <input type="checkbox"/> Joint Research Agreement</p> <p><input type="checkbox"/> Government Interest Assignment</p> <p><input type="checkbox"/> Executive Order 9424, Confirmatory License</p> <p><input type="checkbox"/> Other _____</p>	<p>4. Application or patent number(s): <input checked="" type="checkbox"/> This document is being filed together with a new application.</p> <p>A. Patent Application No.(s) <u>NEW</u></p> <p>B. Patent No.(s) _____</p> <p>Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>
<p>5. Name and address to whom correspondence concerning document should be mailed:</p> <p>Name: <u>Marc S. Weiner</u> <u>BIRCH, STEWART, KOLASCH & BIRCH,</u> <u>LLP</u></p> <p>Internal Address: <u>Atty. Dkt.: 0152-0757PUS1</u></p> <p>Street Address: <u>8110 Gatehouse Road</u> <u>Suite 100 East</u> <u>P.O. Box 747</u></p> <p>City: <u>Falls Church</u></p> <p>State: <u>VA</u> Zip: <u>22040-0747</u></p> <p>Phone Number: <u>(703) 205-8000</u></p> <p>Fax Number: <u>(703) 205-8050</u></p> <p>Email Address: <u>mailroom@bskb.com</u></p>	<p>6. Total number of applications and patents involved: 1</p> <p>7. Total fee (37 CFR 1.21(h) & 3.41) \$ <u>40.00</u></p> <p><input type="checkbox"/> Authorized to be charged by credit card</p> <p><input type="checkbox"/> Authorized to be charged to deposit account</p> <p><input checked="" type="checkbox"/> Enclosed</p> <p><input type="checkbox"/> None required (government interest not affecting title)</p> <p>8. Payment Information</p> <p>a. Credit Card Last 4 Numbers _____ Expiration Date _____</p> <p>b. Deposit Account Number _____ Authorized User Name _____</p>
<p>9. Signature: </p> <p>Signature _____ Date <u>March 23, 2007</u></p> <p><u>Marc S. Weiner - 32,181</u> Name of Person Signing</p> <p>Total number of pages including cover sheet, attachments, and documents: 2</p>	

03/27/2007 LLANDGRA 00000008 11663550
04 FC:8021 40.00 DP

ASSIGNMENT

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar(\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Eisai R&D Management Co., Ltd., a corporation organized under the laws of Japan, located at 6-10, Koishikawa 4-chome, Bunkyo-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Eisai R&D Management Co., Ltd., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

AMORPHOUS OBJECT OF CINNAMIDE COMPOUND

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith,

and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Eisai R&D Management Co., Ltd., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Eisai R&D Management Co., Ltd.

Signed on the date(s) indicated aside signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)	WITNESSES (立会人サイン)
1)	<u>Ikuo Kushida</u> Ikuo KUSHIDA	<u>Dec 26, 2006</u>	<u>Kazuo Ohano</u>
2)	<u>Eriko Doi</u> Eriko DOI	<u>Dec. 26, 2006</u>	<u>Kazuo Ohano</u>
3)	<u>Koichi Ito</u> Koichi ITO	<u>Dec. 26, 2006</u>	<u>Kazuo Ohano</u>
4)	_____	_____	_____
5)	_____	_____	_____
6)	_____	_____	_____
7)	_____	_____	_____
8)	_____	_____	_____
9)	_____	_____	_____